

Wafer Bonding By M. Alexe;U. G÷sele



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or as "ansprengen" in German. By 1900 optical contact bonding was being employed in the construction of optical prisms,

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M. Alexe U. G sele (Eds.) Patents (selection) Method of producing a thin silicon on insulator layer by wafer bonding and chemical thinning. US Patent No. 5,206,523

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Results

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Wafer bonding is another technology to combine Gosele U, Alexe M Fabrication of GaInP/GaAs/Si solar cells by surface activated direct wafer bonding.

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